E·XFL



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Understanding Embedded - PLDs (Programmable Logic Devices)

Embedded - PLDs, or Programmable Logic Devices, are a type of digital electronic component used to build reconfigurable digital circuits. Unlike fixed-function logic devices, PLDs can be programmed to perform specific functions by the user. This flexibility allows designers to customize the logic to meet the exact needs of their applications, making PLDs a crucial component in modern embedded systems.

Applications of Embedded - PLDs (Programmable Logic Devices)

The versatility of PLDs makes them suitable for a wide range of applications. In consumer electronics, PLDs are used to enhance the functionality and performance of

Details

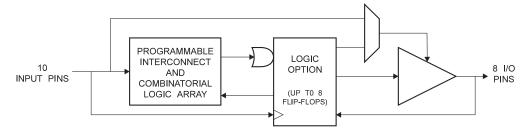
Betans	
Product Status	Obsolete
Programmable Type	EE PLD
Number of Macrocells	8
Voltage - Input	5V
Speed	15 ns
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf16v8cz-15si

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

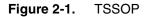


Figure 1-1. Block Diagram



2. Pin Configuration and Pinouts

Table 2-1.	Pinouts - All Pinouts Top View		
Pin Name		Function	
CLK		Clock	
1		Logic Inputs	
I/O		Bi-directional Buffers	
ŌĒ		Output Enable	
VCC		+5V Supply	



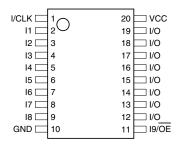
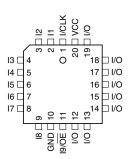


Figure 2-2. DIP/SOIC

		\bigcirc		
I/CLK 🗆	1		20	
l1 🗆	2		19	⊐ I/O
l2 🗆	3		18	⊨ı/o
I3 🗆	4		17	⊨ı/o
I4 🗆	5		16	⊐ I/O
I5 🗆	6		15	⊐ I/O
I6 🗆	7		14	⊐ I/O
I7 🗆	8		13	b I∕O
18 🗆	9		12	b I∕O
GND 🗆	10		11	19/OE

Figure 2-3. PLCC



3. Absolute Maximum Ratings*

Temperature Under Bias40°C to +85°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground2.0V to +7.0V ⁽¹⁾
Voltage on Input Pins with Respect to Ground During Programming2.0V to +14.0V ⁽¹⁾
Programming Voltage with Respect to Ground2.0V to +14.0V ⁽¹⁾

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V_{CC} + 0.75V DC, which may overshoot to 7.0V for pulses of less than 20 ns.

4. DC and AC Operating Conditions

	Commercial	Industrial
Operating Temperature (Ambient)	0°C - 70°C	-40°C - 85°C
V _{CC} Power Supply	5V ±5%	5V ±10%

4.1 DC Characteristics

Symbol	Parameter	Condition	Condition		Тур	Max	Units
I _{IL}	Input or I/O Low Leakage Current	$0 \le V_{IN} \le V_{IL}(Max)$	$0 \le V_{IN} \le V_{IL}(Max)$			-10	μA
I _{IH}	Input or I/O High Leakage Current	$3.5 \le V_{IN} \le V_{CC}$				10	μA
	Device Oversky Overset	15 MHz, V _{CC} = Max,	Com			95	mA
I _{CC1}	I _{CC1} Power Supply Current	$V_{IN} = 0, V_{CC}, Outputs Open$	Ind.			105	mA
. (1)	Power Supply Current,	ent, 0 MHz, $V_{CC} = Max$, $V_{IN} = 0$, V_{CC} , Outputs Open	Com.		5		μA
I _{CC} ⁽¹⁾	CC ⁽¹⁾ Standby Mode		Ind		5		μA
I _{OS}	Output Short Circuit Current	V _{OUT} = 0.5V; V _{CC} = 5V; TA = 25°C				-150	mA
V _{IL}	Input Low Voltage	Min < V _{CC} < Max		-0.5		0.8	V
V _{IH}	Input High Voltage			2.0		V _{CC} +1	V
V _{OL}	Output Low Voltage	V_{CC} = Min, All Outputs I_{OL} = -16 mA	Com, Ind.			0.5	V





4.1 DC Characteristics

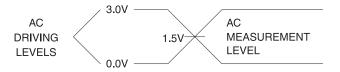
Symbol	Parameter	Condition		Min	Тур	Max	Units
V _{OH}	Output High Voltage	$V_{CC} = Min$ $I_{OL} = -3.2 mA$		2.4			V
		V _{CC} = Min	Com.	24			mA
I _{OL}	OL Output Low Current		Ind.	12			
I _{OH}	Output High Current	V _{CC} = Min	Com., Ind.	4			mA

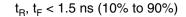
Note: 1. All I_{CC} parameters measured with outputs open. Data is based on Atmel test patterns. Reading may vary with pattern.



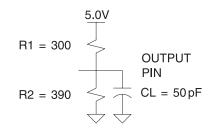
4.4 Input Test Waveforms

4.4.1 Input Test Waveforms and Measurement Levels





4.4.2 Output Test Loads



Note: Similar devices are tested with slightly different loads. These load differences may affect output signals' delay and slew rate. Atmel devices are tested with sufficient margins to meet compatible devices.

4.4.3 Pin Capacitance

	Тур	Max	Units	Conditions
C _{IN}	5	8	pF	$V_{IN} = 0V$
C _{OUT}	6	8	pF	$V_{OUT} = 0V$

Table 4-1. Pin Capacitance (f = 1 MHz, T = $25^{\circ}C^{(1)}$)

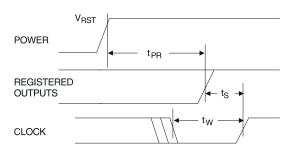
Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

4.5 Power-up Reset

The ATF16V8CZ's registers are designed to reset during power-up. At a point delayed slightly from V_{CC} crossing V_{RST} , all registers will be reset to the low state. As a result, the registered output state will always be high on power-up.

This feature is critical for state machine initialization. However, due to the asynchronous nature of reset and the uncertainty of how V_{CC} actually rises in the system, the following conditions are required:

- 1. The V_{CC} rise must be monotonic, from below 0.7V,
- 2. After reset occurs, all input and feedback setup times must be met before driving the clock term high, and
- 3. The signals from which the clock is derived must remain stable during t_{PR}.



Parameter	Description	Тур	Typ Max	
t _{PR}	Power-up Reset Time	600	1,000	ns
V _{RST}	Power-up Reset Voltage	3.8	4.5	V

4.6 Preload of Registered Outputs

The ATF16V8CZ's registers are provided with circuitry to allow loading of each register with either a high or a low. This feature will simplify testing since any state can be forced into the registers to control test sequencing. A JEDEC file with preload is generated when a source file with vectors is compiled. Once downloaded, the JEDEC file preload sequence will be done automatically by approved programmers.

5. Security Fuse Usage

A single fuse is provided to prevent unauthorized copying of the ATF16V8CZ fuse patterns. Once programmed, fuse verify and preload are inhibited. However, the 64-bit User Signature remains accessible.

The security fuse should be programmed last, as its effect is immediate.





6. Input and I/O Pin-keeper Circuits

The ATF16V8CZ contains internal input and I/O pin-keeper circuits. These circuits allow each ATF16V8CZ pin to hold its previous value even when it is not being driven by an external source or by the device's output buffer. This helps insure that all logic array inputs are at known, valid logic levels. This reduces system power by preventing pins from floating to indeterminate levels. By using pin-keeper circuits rather than pull-up resistors, there is no DC current required to hold the pins in either logic state (high or low).

These pin-keeper circuits are implemented as weak feedback inverters, as shown in the Input Diagram below. These keeper circuits can easily be overdriven by standard TTL- or CMOS-compatible drivers. The typical overdrive current required is 40 μ A.



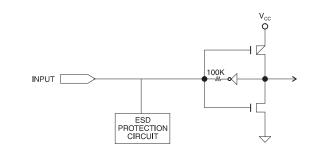
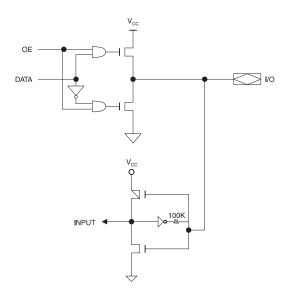


Figure 6-2. I/O Diagram



7. Functional Logic Diagram Description

The Logic Option and Functional Diagrams describe the ATF16V8CZ architecture. Eight configurable macrocells can be configured as a registered output, combinatorial I/O, combinatorial output, or dedicated input.

The ATF16V8CZ can be configured in one of three different modes. Each mode makes the ATF16V8CZ look like a different device. Most PLD compilers can choose the right mode automatically. The user can also force the selection by supplying the compiler with a mode selection. The determining factors would be the usage of register versus combinatorial outputs and dedicated outputs versus outputs with output enable control.

The ATF16V8CZ universal architecture can be programmed to emulate many 20-pin PAL devices. These architectural subsets can be found in each of the configuration modes described in the following pages. The user can download the listed subset device JEDEC programming file to the PLD programmer, and the ATF16V8CZ can be configured to act like the chosen device. Check with your programmer manufacturer for this capability.

Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the content of the ATF16V8CZ. Eight bytes (64 fuses) of User Signature are accessible to the user for purposes such as storing project name, part number, revision, or date. The User Signature is accessible regardless of the state of the security fuse.

	Registered	Complex	Simple	Auto Select
ABEL, Atmel-ABEL	P16C8R	P16V8C	P16V8AS	P16V8
CUPL	G16V8MS	G16V8MA	G16V8AS	G16V8A
LOG/iC	GAL16V8_R ⁽¹⁾	GAL16V8_C7 ⁽¹⁾	GAL16V8_C8 ⁽¹⁾	GAL16V8
OrCAD-PLD	"Registered"	"Complex"	"Simple"	GAL16V8A
PLDesigner	P16V8R	P16V8C	P16V8C	P16V8A
Tango-PLD	G16V8R	G16V8C	G16V8AS	G16V8

Notes: 1. Only applicable for version 3.4 or lower.





8. Macrocell Configuration

Software compilers support the three different OMC modes as different device types. These device types are listed in the table below. Most compilers have the ability to automatically select the device type, generally based on the register usage and output enable (\overline{OE}) usage. Register usage on the device forces the software to choose the registered mode. All combinatorial outputs with \overline{OE} controlled by the product term will force the software to choose the complex mode. The software will choose the simple mode only when all outputs are dedicated combinatorial without \overline{OE} control. The different device types listed in the table can be used to override the automatic device selection by the software. For further details, refer to the compiler software manuals.

When using compiler software to configure the device, the user must pay special attention to the following restrictions in each mode.

In **registered mode** pin 1 and pin 11 are permanently configured as clock and output enable, respectively. These pins cannot be configured as dedicated inputs in the registered mode.

In **complex mode** pin 1 and pin 11 become dedicated inputs and use the feedback paths of pin 19 and pin 12 respectively. Because of this feedback path usage, pin 19 and pin 12 do not have the feedback option in this mode.

In **simple mode** all feedback paths of the output pins are routed via the adjacent pins. In doing so, the two inner most pins (pins 15 and 16) will not have the feedback option as these pins are always configured as dedicated combinatorial output.

8.1 ATF16V8CZ Registered Mode

PAL Device Emulation/PAL Replacement. The registered mode is used if one or more registers are required. Each macrocell can be configured as either a registered or combinatorial output or I/O, or as an input. For a registered output or I/O, the output is enabled by the \overline{OE} pin, and the register is clocked by the CLK pin. Eight product terms are allocated to the sum term. For a combinatorial output or I/O, the output enable is controlled by a product term, and seven product terms are allocated to the sum term. When the macrocell is configured as an input, the output enable is permanently disabled.

Any register usage will make the compiler select this mode. The following registered devices can be emulated using this mode:

16R8	16RP8
16R6	16RP6
16R4	16RP4

8.2 ATF16V8CZ Complex Mode

PAL Device Emulation/PAL Replacement. In the complex mode, combinatorial output and I/O functions are possible. Pins 1 and 11 are regular inputs to the array. Pins 13 through 18 have pin feedback paths back to the AND-array, which makes full I/O capability possible. Pins 12 and 19 (outermost macrocells) are outputs only. They do not have input capability. In this mode, each macrocell has seven product terms going to the sum term and one product term enabling the output.

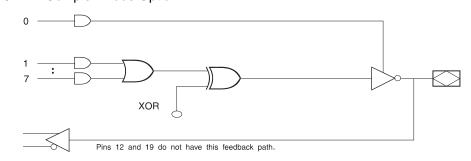
Combinatorial applications with an \overline{OE} requirement will make the compiler select this mode. The following devices can be emulated using this mode:

16L8

16H8

16P8





9. ATF16V8CZ Simple Mode

PAL Device Emulation/PAL Replacement. In the Simple Mode, 8 product terms are allocated to the sum term. Pins 15 and 16 (center macrocells) are permanently configured as combinatorial outputs. Other macrocells can be either inputs or combinatorial outputs with pin feedback to the AND-array. Pins 1 and 11 are regular inputs.

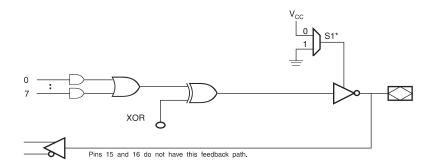
The compiler selects this mode when all outputs are combinatorial without \overline{OE} control. The following simple PALs can be emulated using this mode:

10L8 10H8 10P8 12L6 12H6 12P6 14L4 14H4 14P4 16L2 16H2 16P2

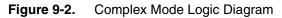




Figure 9-1. Simple Mode Option



* - Pins 15 and 16 are always enabled.



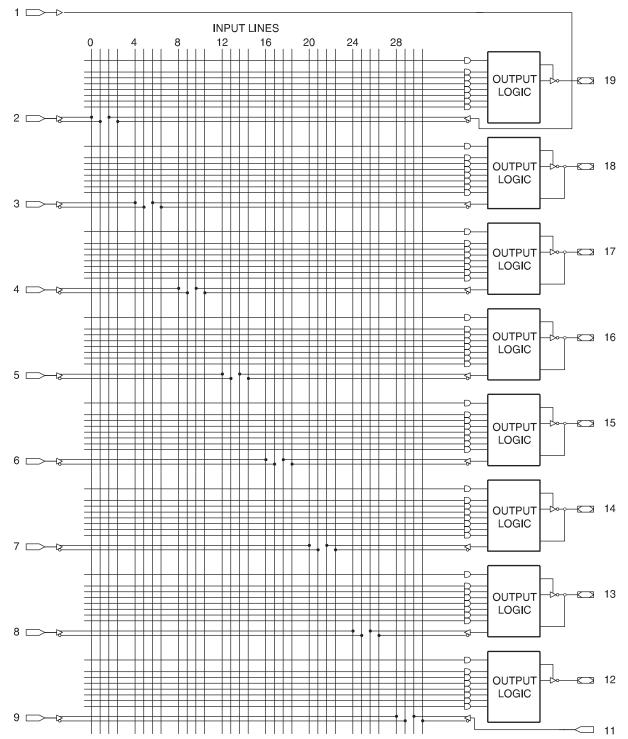
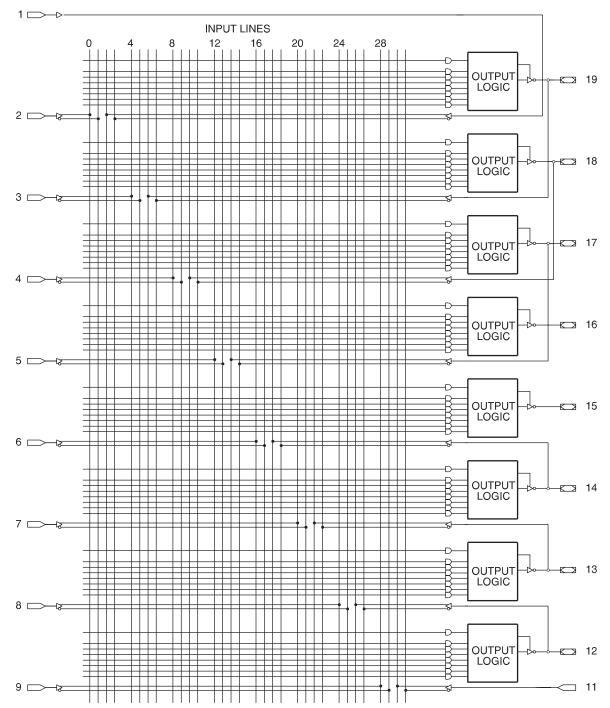




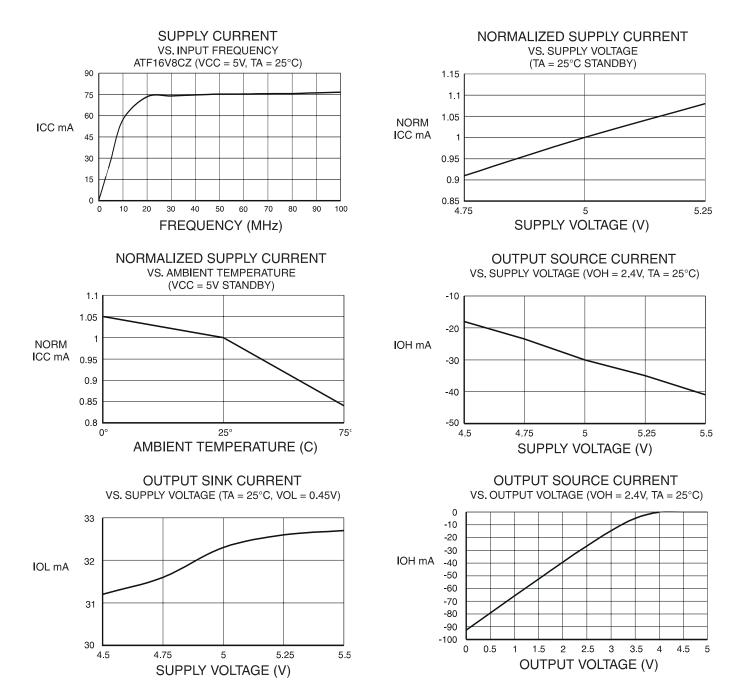


Figure 9-3. Simple Mode Logic Diagram



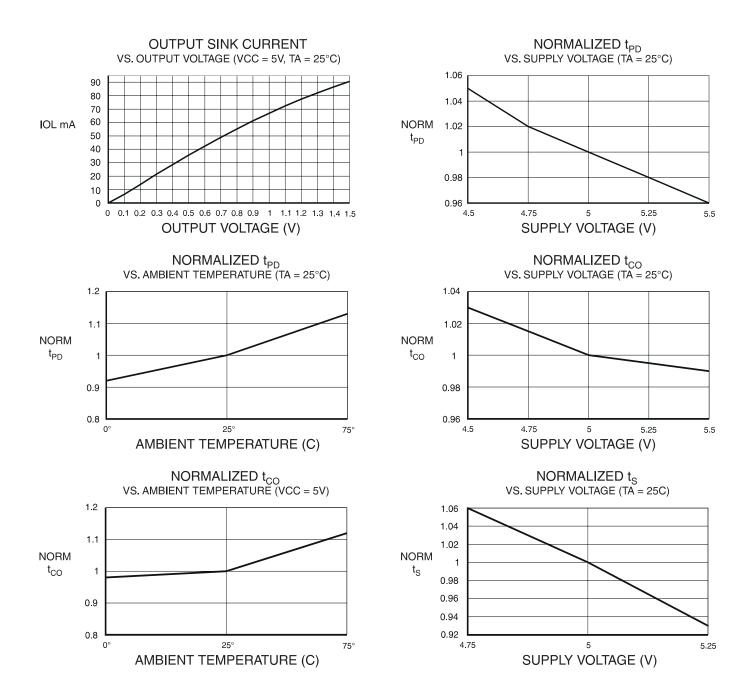
ATF16V8CZ

9.1 Test Characterization Data

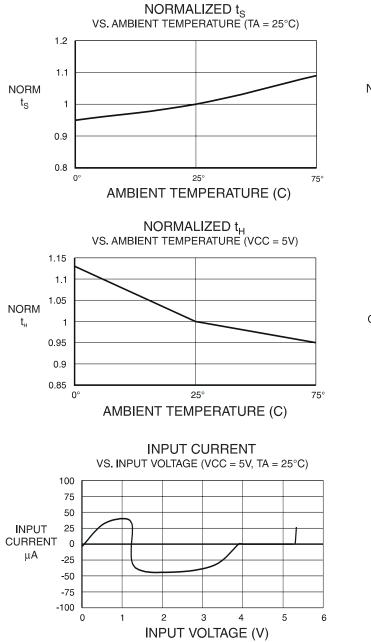


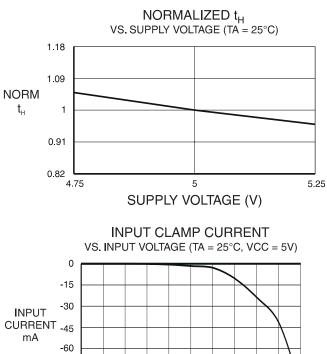






ATF16V8CZ





-.1 -.2 -.3 -.4 -.5 -.6 -.7 -.8 -.9

INPUT VOLTAGE (V)

-1

-75

-90

0





10. Ordering Information

t _{PD} (ns)	t _s (ns)	t _{co} (ns)	Ordering Code	Package	Operation Range
12	10	8	ATF16V8CZ-12JC ATF16V8CZ-12PC ATF16V8CZ-12SC ATF16V8CZ-12XC	20J 20P3 20S 20X	Commercial (0°C to 70°C)
15	12	10	ATF16V8CZ-15JC ATF16V8CZ-15PC ATF16V8CZ-15SC ATF16V8CZ-15XC	20J 20P3 20S 20X	Commercial (0°C to 70°C)
	12	10	ATF16V8CZ-15JI ATF16V8CZ-15PI ATF16V8CZ-15SI ATF16V8CZ-15XI	20J 20P3 20S 20X	Industrial (-40°C to 85°C)

10.1 Standard Package Options

Note: Shaded parts are being obsoleted in Q3-05 and being replaced by Green parts.

10.2 Using "C" Product for Industrial

To use commercial product for Industrial temperature ranges, down-grade one speed grade from the "I" to the "C" device (7 ns "C" = 10 ns "I") and de-rate power by 30%.

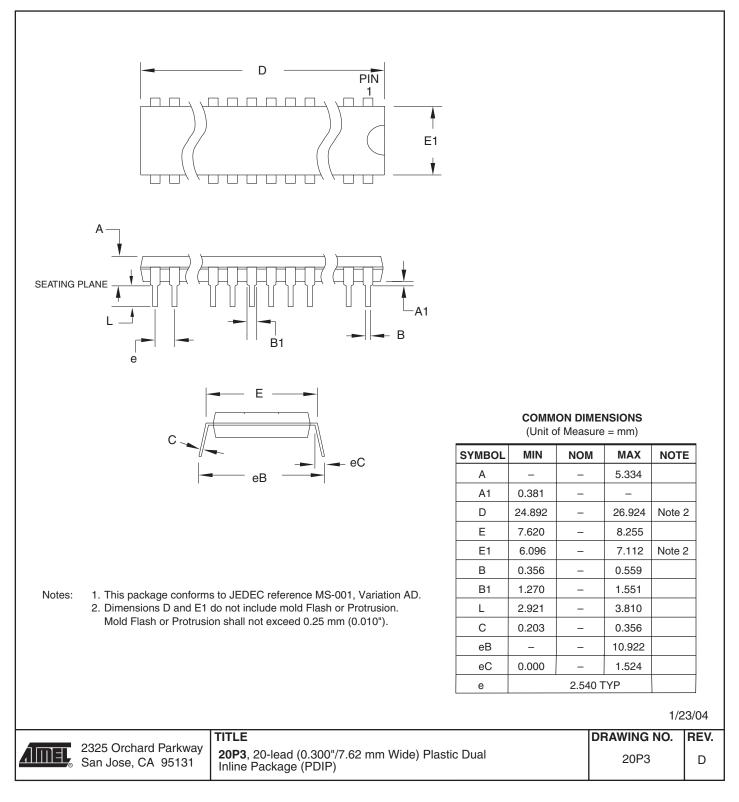
10.3 Green Package Options (Pb/Halide-free/RoHS Compliant)

t _{PD} (ns)	t _s (ns)	t _{co} (ns)	Ordering Code	Package	Operation Range
15	12	10	ATF16V8CZ-15JU	20J	
			ATF16V8CZ-15PU	20P3	Industrial
			ATF16V8CZ-15SU	20S	(-40°C to 85°C)
			ATF16V8CZ-15XU	20X	

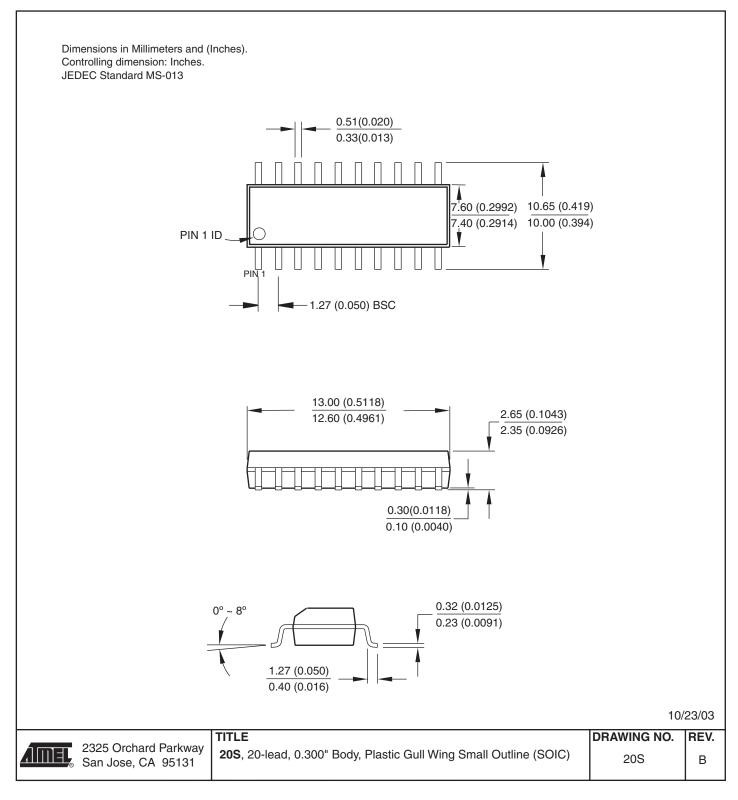
Package Type				
20J	20-lead, Plastic J-leaded Chip Carrier (PLCC)			
20P3	20-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)			
20S	20-lead, 0.300" Wide, Plastic Gull-wing Small Outline (SOIC)			
20X	20-lead, 4.4 mm Wide, Plastic Thin Shrink Small Outline (TSSOP)			



11.2 20P3 - PDIP



11.3 20S - SOIC





12. Revision History

- 12.1 0453H
- 1. Green Package options added in 2005.





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